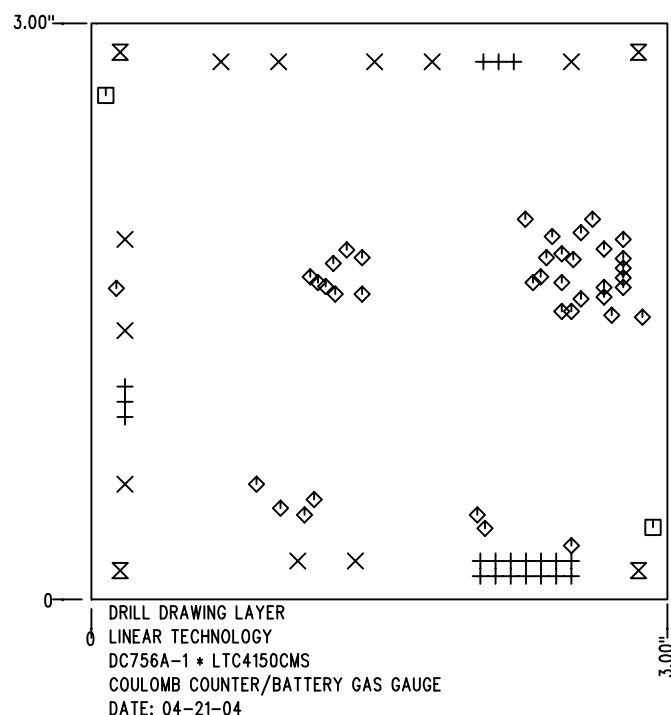


REVISIONS			
REV	DESCRIPTION	APPR	DATE
A	PROTOTYPE RELEASE		



SHOWN FROM COMPONENT SIDE


SIZE	QTY	SYM	PLTD
0.035	20	+	PLTD
0.094	10	X	PLTD
0.07	2	□	NPLTD
0.015	39	◇	PLTD
0.19	4	⊗	PLTD

#### NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD  
THICKNESS .062 +/- .006 TOTAL OF 2 LAYERS.
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE  
ELECTRODEPOSITED TIN-LEAD COMPOSITION  
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC).
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT.
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK.
5. UNUSED SMD COMPONENTS SHOULD BE FREE OF SOLDER.
6. FILL UP ALL VIAS WITH SOLDER.
7. SCORING:



8. PLEASE LOOK AT THE README FILE FOR THE OTHER REQUIREMENTS.

APPROVALS			 1630 MCCATHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
DRAWN	INIT	DATE		
CHECK			TITLE: FABRICATION DRAWING COULOMB COUNTER/BATTERY GAS GAUGE	
DESIGN	KIM T.	04-21-04		
ENGR	DILIAN R.	04-21-04	SIZE A DEMO DC756A-1*LTC4150CMS REV. A	
SCALE = NONE			DES- 0000	SHT 1 of 1